



Product Change Notification

106386 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 106386 - 00
Change Title: Intel NetStructure® MPCMM0001 Chassis Management Module, PCN 106386-00, Product Material, Changes made to Faceplate, Packaging, Inductor and Mylar Label
Date of Publication: June 01, 2006

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jun 16, 2006
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Description of Change to the Customer:

- 1) Slight change to faceplate finish due to change in supplier. No form-fit-function change to faceplate.
- 2) Inductor L701 changed from non-RoHS compliant part to RoHS compliant part due to supplier discontinuance of the non-RoHS part
- 3) Packaging material change to migrate to standardized packaging.
- 4) Faceplate overlay dimension improvements to prevent overhang.

Customer Impact of Change and Recommended Action:

No impact to customers.

Products Affected / Intel Ordering Codes:

Board Products Table

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA or AA	Post-Change TA or AA	Pre-Change PBA	Post-Change PBA
MPCMM0001	850830	850830	C52711-020	C52711-021	A97016-604	A97016-605

Reference Documents / Attachments:

Document: _____ **Location #:** _____

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
June 1, 2006	00	Originally Published PCN

